EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L14	1	"6068002".pn.	USPAT	OR	ON	2007/08/03 10:46
L15	2	10/013550.app.	US-PGPUB; USPAT	OR	ON	2007/08/03 10:46
S1	0	("6299696.pn.").PN.	USPAT	OR	OFF	2007/07/31 16:05
S2	1	"6299696".pn.	USPAT	OR	ON	2007/07/30 13:15
S3	28	("5485644" | "5503708" | "5520744" | "6001191" | "6045624" | "6050275" | "6068002" | "6146467" | "6158141" | "6158449" | "6164297" | "6165279").PN. OR ("6299696").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/30 13:16
S4	13	("4524719" | "5191908" | "5232328" | "5370142" | "5520744" | "5569330" | "5660517" | "5678320" | "5784797" | "6068002" | "6158449" | "6171403" | "6299696").PN. OR ("6799586").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/30 13:33
S5	44	("4132567" | "4286541" | "4911761" | "5222310" | "5409310" | "5431178" | "5520744" | "5569330" | "5571337" | "5666985" | "5738128" | "5752532" | "5896875").PN. OR ("6164297").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 09:24
S6	55856	(wafer semiconductor substrate) and (shutter separation plate) with (slits holes)	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/30 14:10
S7	33669	(wafer semiconductor substrate) and (shutter separation plate) with (slits holes)	USPAT	OR	ON	2007/07/30 14:11
S8	22	(wafer semiconductor substrate) and (shutter separation plate) with (slits holes) with (exhaust drain) with (clean wash dry)	USPAT	OR	ON	2007/07/31 16:15
S9	167	68/12.02.ccls.	USPAT	OR	ON	2007/07/30 14:18
S10	1994	134/2.ccls.	USPAT	OR	ON	2007/08/01 10:54
S11	33	134/2.ccls. and (shutter plate) with (holes vent slits)	USPAT	OR	ON	2007/08/01 10:57
S12	0	134/2.ccls. and (shutter baffer plate) with (holes vent slits) not S11	USPAT	OR	ON	2007/07/30 14:23
S13	1	134/2.ccls. and (shutter baffle plate) with (holes vent slits) not S11	USPAT	OR	ON	2007/08/01 09:17

S14	5	(cleaning adj drying adj apparatus) and (shutter baffle plate) with (holes vent slits) and (semiconductor waffer substrate)	USPAT	OR	ON	2007/07/30 14:28
S15	62	(cleaning adj2 drying adj2 apparatus) and ((shutter baffle plate) with2 (holes vent slits)) and (semiconductor waffer substrate)	USPAT	OR	ON	2007/07/30 14:28
S16	18	("4132235" | "4558524" | "4694527" | "4983223" | "5186192" | "5368649" | "5369891" | "5443540" | "5520744" | "5657553" | "5940985" | "6001191" | "6045624" | "6050275" | "6068002" | "6158449" | "6164297" | "6342104").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/07/30 15:23
S17	3	"2003292523"	JPO; DERWENT	OR	ON	2007/07/30 15:24
S18	3	"2003292523"	JPO; DERWENT	OR	ON	2007/07/30 15:24
S19	39998	(shutter disc baffle plate) with (holes vent slits exhaust) and (semiconductor wafer substrate)	USPAT	OR	ON	2007/07/30 15:45
S20	379	(shutter disc baffle plate) with (holes vent slits exhaust) and (semiconductor wafer substrate) and clean near3 dry	USPAT	OR	ON	2007/07/30 15:45
S21	0	(shutter disc baffle plate) with (holes vent slits exhaust) and (semiconductor wafer substrate) and (clean near3 dry).ti.	USPAT	OR	ON	2007/07/30 15:46
S22	256	(shutter disc baffle plate) with (holes vent slits exhaust) and (semiconductor wafer substrate) and (clean adj4 dry)	USPAT	OR	ON	2007/07/30 15:46
S23	236	(shutter disc baffle plate) with (holes vent slits exhaust) and (semiconductor wafer substrate) and (clean adj2 dry)	USPAT	OR	ON	2007/08/01 09:11
S24	198	(shutter disc baffle plate) with (holes vent slits) and (semiconductor wafer substrate) and (clean adj2 dry)	USPAT	OR	ON	2007/07/30 15:48
S25	49	134/2.ccls. and (clean adj2 dry)	USPAT	OR	ON	2007/07/30 16:15
S27	21	(wafer semiconductor substrate) and (shutter plate baffle) with (slits holes slot) with (exhaust drain) with (clean wash dry)	USPAT	OR	ON	2007/07/31 16:17

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S28	675772	(wafer semiconductor substrate) and (shutter plate baffle) (exhaust drain)with (exhaust drain communicate)	USPAT	OR	ON	2007/07/31 16:21
S29	675772	(wafer semiconductor substrate) and (shutter plate baffle) (exhaust drain) with (exhaust drain communicate)	USPAT	OR	ON	2007/07/31 16:21
S30	4123	(wafer semiconductor substrate) and (shutter plate baffle sprinkler) with (exhaust drain communicate) and (clean$3 dry$3)	USPAT	OR	ON	2007/07/31 16:22
S31	1022337	(wafer semiconductor substrate) and (shutter plate baffle sprinkler) with (exhaust drain communicate) with2 (clean$3 dry$3)	USPAT	OR	ON	2007/07/31 16:22
S32	245	(wafer semiconductor substrate) and (shutter plate baffle sprinkler) with (exhaust drain communicate) with (clean$3 dry$3)	USPAT	OR	ON	2007/07/31 16:23
S33	36	(wafer semiconductor substrate) and (shutter plate baffle sprinkler) with (exhaust drain communicate) with (clean$3 dry$3) with (hole slot slit)	USPAT	OR	ON	2007/07/31 16:42
S34	2	(wafer semiconductor substrate) and (shutter plate baffle sprinkler) with (exhaust drain communicate) with (clean$3 dry$3) with (perforat$3)	USPAT	OR	ON	2007/07/31 16:43
S35	76	(wafer semiconductor substrate) and (shutter plate baffle sprinkler) with (exhaust drain communicate) with (perforat$3) and (clean$3 dry$3)	USPAT	OR	ON	2007/07/31 16:44
S36	56	(shutter disc baffle plate) with (porous) and (semiconductor wafer substrate) and (clean adj2 dry)	USPAT	OR	ON	2007/08/01 09:12
S37	18	(US-6164297-$ or US-6799586-$ or US-6299696-$ or US-6746543-$ or US-6354311-$ or US-5369891-$ or US-6625901-$ or US-5482068-$ or US-6312171-$ or US-6333003-$ or US-5524361-$ or US-6018144-$ or US-5997685-$ or US-5885353-$ or US-5226056-$ or US-4979435-$ or US-5265632-$ or US-5311893-$). did.	USPAT	OR	ON	2007/08/01 09:18
S38	2	S37 and porous	USPAT	OR	ON	2007/08/01 09:19

S39	45	("4132567" | "4286541" | "4911761" | "5222310" | "5409310" | "5431178" | "5520744" | "5569330" | "5571337" | "5666985" | "5738128" | "5752532" | "5896875").PN. OR ("6164297"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 09:24
S40	6	S39 and porous	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 09:25
S41	22	(wafer semiconductor substrate) and (shutter separation plate) with (slits holes) with (exhaust drain) with (clean wash dry)	USPAT	OR	ON	2007/08/01 09:26
S42	167	68/12.02.ccls.	USPAT	OR	ON	2007/08/01 09:26
S43	62	(cleaning adj2 drying adj2 apparatus) and ((shutter baffle plate) with2 (holes vent slits)) and (semiconductor waffer substrate)	USPAT	OR	ON	2007/08/01 09:26
S44	379	(shutter disc baffle plate) with (holes vent slits exhaust) and (semiconductor wafer substrate) and clean near3 dry	USPAT	OR	ON	2007/08/01 09:26
S45	256	(shutter disc baffle plate) with (holes vent slits exhaust) and (semiconductor wafer substrate) and (clean adj4 dry)	USPAT	OR	ON	2007/08/01 09:26
S46	236	(shutter disc baffle plate) with (holes vent slits exhaust) and (semiconductor wafer substrate) and (clean adj2 dry)	USPAT	OR	ON	2007/08/01 09:26
S47	198	(shutter disc baffle plate) with (holes vent slits) and (semiconductor wafer substrate) and (clean adj2 dry)	USPAT	OR	ON	2007/08/01 09:26
S48	49	134/2.ccls. and (clean adj2 dry)	USPAT	OR	ON	2007/08/01 09:26
S49	76	(wafer semiconductor substrate) and (shutter plate baffle sprinkler) with (exhaust drain communicate) with (perforat$3) and (clean$3 dry$3)	USPAT	OR	ON	2007/08/01 09:26
S50	133	(S41 or S42 or S43 or S44 S45 S46 S47 S48 S49) and porous	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 09:42
S51	1	"6299696".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 09:42

S52	28	("5485644" | "5503708" | "5520744" | "6001191" | "6045624" | "6050275" | "6068002" | "6146467" | "6158141" | "6158449" | "6164297" | "6165279").PN. OR ("6299696").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 09:42
S53	6	("6655042" "695823" "6905570" "6883248" "6713440" "6655042" "7255115" "6959823" "6905570" "7223721").pn.	USPAT	OR	ON	2007/08/01 10:29
S54	165	164/61.ccls.	USPAT	OR	ON	2007/08/01 11:00
S55	269	134/61.ccls.	USPAT	OR	ON	2007/08/01 12:28
S56	128	(substrate adj processing adj apparatus) and ((first second) adj2 chamber)	USPAT	OR	ON	2007/08/01 12:32
S57	106	(substrate adj processing adj apparatus) and ((first second) adj2 chamber) and (baffle weir plate shutter disc)	USPAT	OR	ON	2007/08/01 12:39
S58	87	(substrate adj processing adj apparatus) and ((first second) adj2 chamber) and (baffle weir plate shutter disc) and (clean$3 dry$3)	USPAT	OR	ON	2007/08/01 13:36
S59	1	"20030159718"	US-PGPUB	OR	ON	2007/08/01 13:42
S60	19	"6342104" "6050275"	US-PGPUB; USPAT	OR	ON	2007/08/01 13:42
S61	2	("6342104" "6050275").pn.	US-PGPUB; USPAT	OR	ON	2007/08/01 13:43